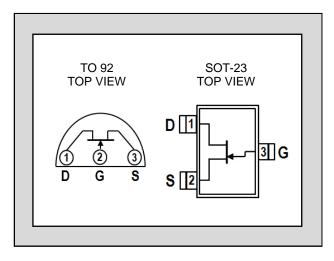


### Twenty-Five Years Of Quality Through Innovation

FEATURES						
ULTRA LOW NOISE	$e_n = 1.8 \text{nV}/\sqrt{\text{Hz}}$					
LOW INPUT CAPACITANCE	C <sub>ISS</sub> = 4pF					
ABSOLUTE MAXIMUM RATINGS <sup>1</sup> @ 25 °C (unless otherwise stated)						
Maximum Temperatures						
Storage Temperature	-55 to +150°C					
Junction Operating Temperature	-55 to +150°C					
Maximum Power Dissipation						
Continuous Power Dissipation TA=25°C	300mW <sup>4</sup>					
Maximum Currents						
Gate Forward Current	$I_{G(F)} = 10mA$					
Maximum Voltages						
Gate to Source	V <sub>GSO</sub> = 60V					
Gate to Drain	$V_{GDO} = 60V$					

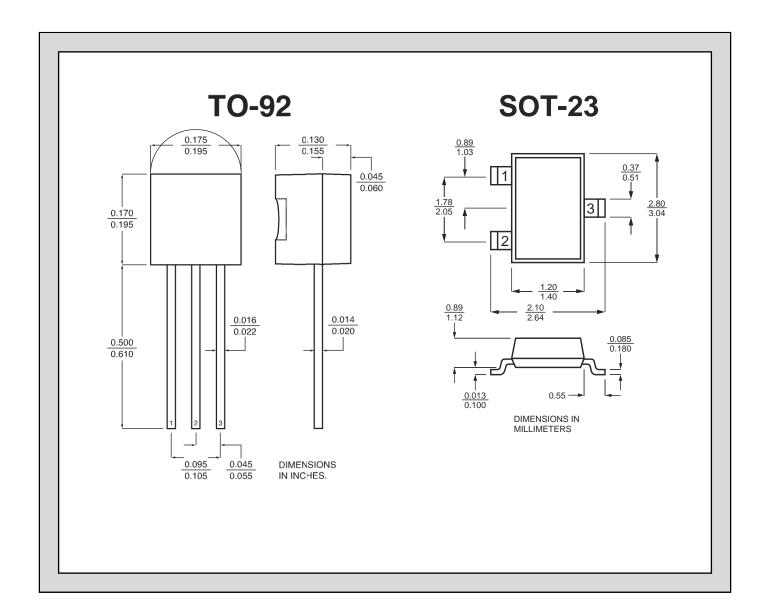
## **LSK189**

# LOW NOISE, LOW CAPACITANCE SINGLE N-CHANNEL JFET



<sup>\*</sup> For equivalent monolithic dual, see LSK489

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS	
BV <sub>GSS</sub>	Gate to Source Breakdown Voltage	-60			V	$V_{DS} = 0$ , $I_{D} = -1nA$	
$V_{GS(OFF)}$	Gate to Source Pinch-off Voltage	-1.5		-3.5	V	$V_{DS} = 15V, I_{D} = 1nA$	
V <sub>G</sub> s	Gate to Source Operating Voltage	-0.5		-3.5	V	$V_{DS} = 15V, I_D = 500\mu A$	
$I_{DSS}^2$	Drain to Source Saturation Current	2.5	5	15	mA	$V_{DS} = 15V, V_{GS} = 0$	
lg	Cata Operating Current		-2	-25	pА	V <sub>DG</sub> = 15V, I <sub>D</sub> = 200μA	
lg	Gate Operating Current		-0.8	-10	nA	TA	A=125°C
Igss	Gate to Source Leakage Current			-100	рΑ	V <sub>GS</sub> = -15V	
G <sub>fs</sub>	Full Conductance Transconductance	1500			μS	$V_{DS} = 15V, V_{GS} = 0, f = 1kHz$	
		1000	1500		μS	V <sub>DS</sub> = 15V, I <sub>D</sub> = 500μA	
Gos	Full Output Conductance			40	μS	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0	
Gos	Output Conductance		1.8	2.7	μS	V <sub>DS</sub> = 15V, I <sub>D</sub> = 200μA	
NF	Noise Figure			0.5	dB	$V_{DS} = 15V$ , $V_{GS} = 0$ , $R_{G} = 10M\Omega$ , $f = 100Hz$ , $NBW = 6Hz$	
en	Noise Voltage		1.8	2.0	nV/√Hz	$V_{DS} = 15V, I_{D} = 2mA, f = 1kHz,$ NBW = 1Hz	
<b>e</b> n	Noise Voltage		2.8	3.5	nV/√Hz	$V_{DS} = 15V$ , $I_{D} = 2mA$ , $f = 10Hz$ , $NBW = 1Hz$	
Ciss	Common Source Input Capacitance		4	8	pF	$V_{DS} = 15V$ , $I_{D} = 500\mu A$ , $f = 1MHz$	
Crss	Common Source Reverse Transfer Cap.			3	pF		

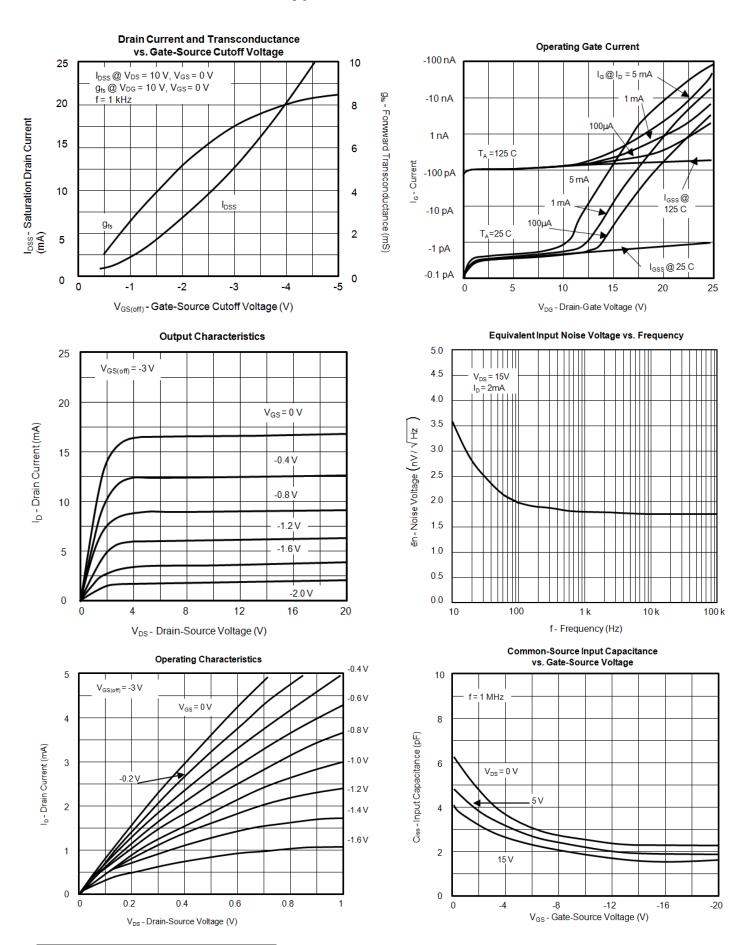


#### **NOTES:**

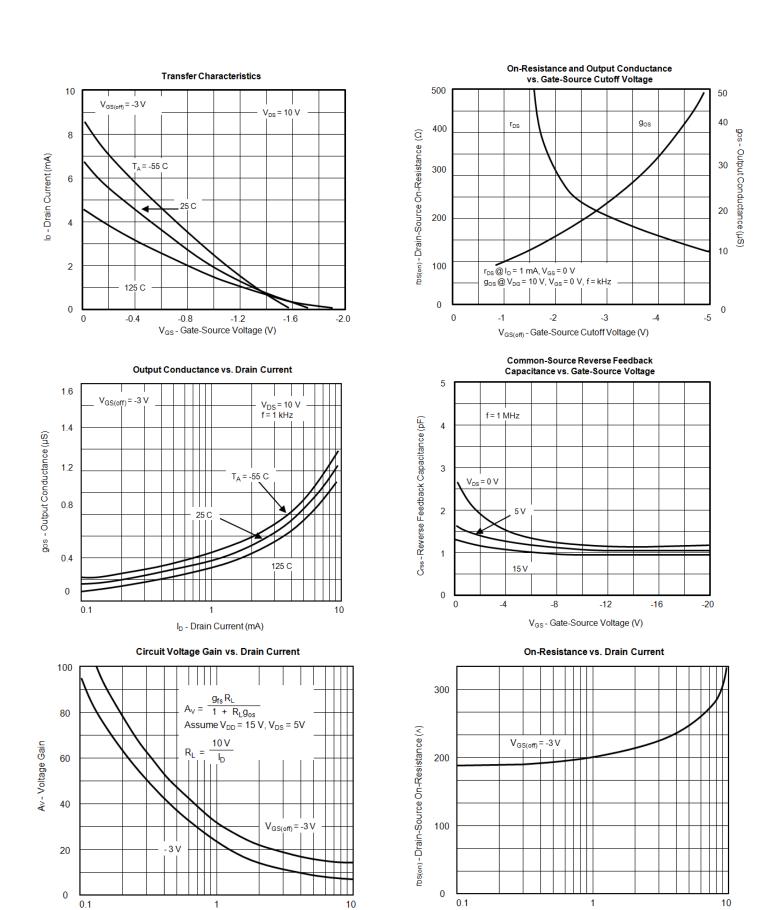
- 1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
- 2. Pulse Test: PW ≤ 300µs, Duty Cycle ≤ 3%.
- 3. All characteristics MIN/TYP/MAX numbers are absolute values. Negative values indicate electrical polarity only.
- 4. Derate 2.8 mW °C above 25°C.

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## **Typical Characteristics**



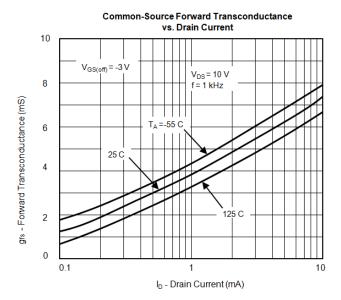
## **Typical Characteristics (Cont'd)**



ID - Drain Current (mA)

ID - Drain Current (mA)

## **Typical Characteristics (Cont'd)**



Linear Integrated Systems (LIS) is a 25-year-old, third-generation precision semiconductor company providing high-quality discrete components. Expertise brought to LIS is based on processes and products developed at Amelco, Union Carbide, Intersil and Micro Power Systems by company President John H. Hall. Hall, a protégé of Silicon Valley legend Dr. Jean Hoerni, was the director of IC Development at Union Carbide, Co-Founder and Vice President of R&D at Intersil, and Founder/President of Micro Power Systems.